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Response
8-22-03
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of)
Hayakawa et al.)
Serial No.: 09/532,915)
Filed: March 22, 2000)
For: Semiconductor Device and Method)
of Manufacturing The Same)
Art Unit: 2826)
Examiner: Sefer, A.)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to:
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(Date of Deposit)

Shannon Wallace

Name of applicant, assignee, or Registered Rep.

Shannon Wallace 8/4/03
Signature Date

Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT E (AFTER FINAL)

Sir:

In response to the Advisory Action of July 25, 2003 and the Final Rejection of February 4, 2003, a prior response having been filed on June 19, 2003, and a RCE and three month extension of time being submitted herewith, please amend the above-identified application as follows:

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